#### **General Description**

The MAX2837 evaluation kit (EV kit) simplifies testing of the device's receive and transmit performance in WiMAX applications operating in the 2.3GHz to 2.7GHz ISM band. The EV kit provides  $50\Omega$  SMA connectors for all RF and baseband inputs and outputs. Differential-to-single-ended and single-ended-to-differential line drivers are provided to convert the differential I/Q baseband inputs and outputs to single-ended.

#### **Features**

- On-Board Line Driver and Voltage Reference
- 50Ω SMA Connectors on All RF and Baseband Ports
- PC Control Software Available at www.maximintegrated.com/evkitsoftware)

#### **Quick Start**

#### **Recommended Test Equipment**

This section lists the recommended test equipment to verify the operation of the MAX2837. It is intended as a guide only and substitutions may be possible.

- MAX2837 EV kit
- INTF3000+ interface board
- DC supply capable of delivering +5V and 250mA of continuous current
- DC supply capable of delivering -5V and 250mA of continuous current
- DC supply capable of delivering +3.3V and 250mA of continuous current
- Two HP8648s or equivalent signal sources capable of generating 0dBm up to 3GHz
- Two HP or equivalent arbitrary waveform generators
- One HP8561E or equivalent RF spectrum analyzer with a minimum 100kHz to 3GHz frequency range
- One TDS3012 or equivalent oscilloscope with 200MHz bandwidth
- PC laptop or tablet with Microsoft Windows XP<sup>®</sup>, Windows<sup>®</sup> 7, 8 OS and a USB port
- USB-A male to USB-B male cable

Windows and Windows XP are registered trademarks and registered service marks of Microsoft Corporation.

#### **Connections and Setup**

The EV kit is fully assembled and factory tested. Follow the instructions below to test the device. This section provides step-by-step instructions for getting the EV kit up and running in all modes. See Figure 1 for EV kit connections:

- Connect the PC to the INTF3000 interface board using the USB-A male to USB-B male cable. On the INTF3000, remove jumper JU1 and connect a DC supply set to 3.3V to the VPULL connector. Connect the 25-pin connector of the INTF3000 (J4) directly to the 25-pin connector on the EV kit (J18).
- With the power supply turned off, connect the +3.3V power-supply to VBAT and VCCAUX. Connect the power-supply ground to the header labeled GND1.
- 3) With the power supply turned off, connect the +5V power supply to the +5V test point and the -5V power supply to the -5V test point. Connect the power-supply ground to the header labeled GND2. Connect all the power-supply grounds together.
- 4) Set the RXBBBUF jumper across pins 1-2 to enable the RX baseband buffers.
- Set the VCCVCO jumper across pins 2-3, VCCVCO1 jumper across pins 1-2, VCCVCO2 jumper across pins 2-3, and VBAT\_LDO jumper across pins 2-3 to utilize the three on-board LDOs to regulate the VBAT voltage to +2.85V.
- 6) Turn on the +3.3V power supply, and the +5V and -5V power supplies.
- 7) Make sure there are no jumpers across headers labeled RXEN, TXEN and JPSHDNB so that these enables can be controlled through the software.
- Adjust the TX common-mode potentiometer (R36) until measuring 0.9V common-mode voltage at the VCM test point (see <u>Figure 1</u> for locations).
- 9) Install and run the MAX2837 control software from HERE.
- 10) In the **Enables** panel of the software, check the EN\_SPI box to enable the 3-wire interface.
- 11) In the **Synth** panel of the software, set the LO frequency to 2500MHz.
- 12) In the **Registers** panel of the software, set ENABLE to 1 and RXENABLE and TXENABLE to 0 to put the IC into standby mode. The supply current should be around 35mA.



#### **Receive Mode**

- Set the signal generator to accurately deliver -100dBm at 2502MHz. Connect the output of the signal generator to RXRF port of the EV kit.
- Connect either the RXBBI or RXBBQ baseband output to a spectrum analyzer. Set the center frequency to 2MHz and the span to 1MHz. Other recommended spectrum analyzer settings are: Res BW of 3kHz, Attenuation of 40dB, and Ref Level of 30dB.
- In the Registers panel of the software, set ENABLE and RXENABLE to 1 and TXENABLE to 0 to activate the receive path. The current should be around 94mA.
- In the RX panel of the software, toggle both the LNA gain enable and the baseband VGA enable to be SPI. Set both of the gain controls to max.
- 5) Turn on the RF signal source. The output CW tone at 2MHz should be approximately -2dBm.

#### **Transmit Mode**

- Connect the spectrum analyzer to the TXRF port. Set the center frequency to 2500MHz and the span to 5MHz. Other recommended spectrum analyzer settings are: Res BW of 10kHz, Attenuation of 10dB and Ref Level of 0dB.
- Connect a 2MHz sinusoid to TXBBI and a 2MHz sinusoid with a 90° phase shift (or a cosine) to TXBBQ. Set the input amplitude of each channel to 90mV<sub>RMS</sub>.
- 3) In the **Registers** panel of the software, set ENABLE and TXENABLE to 1 and RXENABLE to 0 to activate the transmit path. The current should be around 146mA.
- 4) In the **TX** panel of the software, toggle TX VGA Gain to SPI. Set it to -3dB from the max gain.
- 5) In the **TX** panel of the software, set the TX Mixer V2I gain to -5.5dB (this is also the default setting).
- Turn on the baseband signal sources. The output at 2502MHz should be approximately -1dBm. The LO leakage at 2500MHz should be around -27dBm and sideband suppression at 2498MHz should be around -39dBm.

#### **Layout Considerations**

The EV kit can serve as a guide for board layout. Keep PCB trace lengths as short as possible to minimize parasitic inductance. Also, keep decoupling capacitors as close to the IC as possible with a direct connection to the ground plane.

#### **Power-Supply Layout**

To minimize coupling between different sections of the IC, use a "star" power-supply routing configuration with a large decoupling capacitor at a central  $V_{CC}$  node. The  $V_{CC}$  traces branch out from this node, each going to a separate  $V_{CC}$  node in the circuit. Place a bypass capacitor as close to each supply pin as possible. This arrangement provides local decoupling at each  $V_{CC}$  pin. Use at least one via per bypass capacitor for a low-inductance ground connection. Do not share the capacitor ground vias with any other branch.

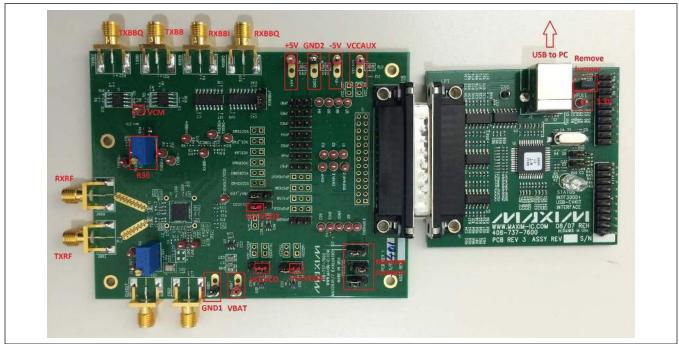


Figure 1. MAX2837 EV Kit Connections

## **Component Suppliers**

SUPPLIER	WEBSITE
Digi-Key Corp.	www.digikey.com
Johnson Components	www.johnsoncomponents.com
Murata Americas	www.murata.com
Texas Instruments Inc.	www.ti.com

Note: Indicate that you are using the MAX2837 when contacting these component suppliers.

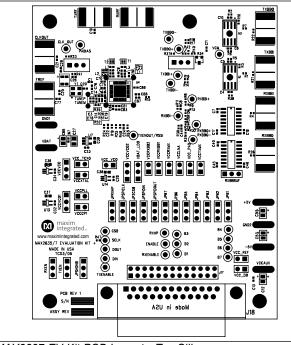
#### MAX2837 EV Kit Bill of Materials

DESIGNATION	QTY	DESCRIPTION	
+5V, -5V, VBAT, VCCAUX	4	Test points, PCB red Keystone 5010	
B1–B7, CLK_OUT, CSB, DIN, DOUT, ENABLE, PABIAS, RXBBI+, RXBBI-, RXBBQ+, RXBBQ-, RXENABLE, RXHP, SCLK, TXBBI+ TXBBI-, TXBBQ+, TXBBI-, TUNEM, TUNEP, TXENABLE, RSSI, VCM	29	Test points, PCB mini-red Keystone 5000	
GND1, GND2	2	Test points, PCB black Keystone 5011	
J17, JP2CSB, JPSPICLK, JPSPIDIN, JPSPIDOUT, L3, L4, L7, VCCCP1, VCCLNA, VCCPLL, VCCRXBB1, VCCRXBB2, VCCRXMX, VCCTXMX, VCCXTAL, VCC_DB, VCC_PAD, VCC_REF, VCC_TCXO, VCC_VCO, Y1	0	Not installed	
JPB1–JPB7, JPSHDNB, RXBBBUF, RXEN, TXEN, VCCVCO, VCCVCO1, VCCVCO2	16	1 x 3-pin headers Sullins PEC36SAAN	
C1, C3, C8, C20–C22, C24, C44, C76, C78	0	Not installed, capacitors	
C2, C9, C15, C16, C19, C70, C89	7	22pF ±5% ceramic capacitors (0402) Murata GRM1555C1H220J	
C4–C7, C10, C13, C17, C18, C40, C45, C46, C59, C60, C67, C83	15	0.1µF ±10% ceramic capacitors (0402) Murata GRM155R61C104K	
C11, C23, C26, C28, C32, C34, C73, C74, C75, C87, C88	11	0.01µF ±10% ceramic capacitors (0402) Murata GRM155R71E103K	
C12, C53, C55, C66	4	10μF ±10% ceramic capacitors (0805) Murata GRM21BR61A106K	
C14	1	3300pF ±10% ceramic capacitor (0402) Murata GRM155R71H332K	
C25, C77	2	1000pF ±10% ceramic capacitors (0402) Murata GRM155R71H102K	
C27	1	2.2µF ±10% ceramic capacitor (0805) Murata GRM21BR71A225K	
C29, C86	2	1µF ±10% ceramic capacitors (0402) Murata GRM155R61J105K	
C36–C39	4	2.2µF ±10% ceramic capacitors (0603) Murata GRM188R61A225K	
C68, C69	2	3pF ±5% ceramic capacitors (0402) Murata GRM1555C1H3R0J	
C79	1	180pF ±5% ceramic capacitor (0402) Murata GRM1555C1H181J	
C81	1	100pF ±5% ceramic capacitor (0402) Murata GRM1555C1H101J	
J18	1	DB25 right-angle male connector AMP 5747238-4	

## MAX2837 EV Kit Bill of Materials (continued)

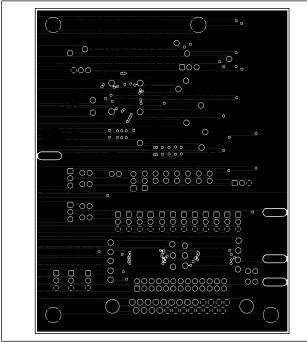
DESIGNATION	QTY	DESCRIPTION			
L1	1	6.2nH ±0.1nH inductor Murata LQ15AN6N2B00			
R1, R7	2	200Ω ±1% resistors (0402)			
R2, R5, R6, R38	4	205Ω ±1% resistors (0402)			
R3, R10	2	226Ω ±1% resistors (0402)			
R4, R26	2	49.9Ω ±1% resistors (0402)			
R8, R9, R12–R19, R23, R24, R25, R28, 29, R31, R32, R40, R41, R45, R47, R48	22	0Ω resistors (0402)			
R11, R30, R35, R42, R50, R52	0	Not installed, resistors			
R20, R51	2	475Ω ±1% resistors (0402)			
R21, R22	2	61.9Ω ±1% resistors (0402)			
R33, R36	2	Trimmer potentiometers Bourns 3296W-1-102LF			
R34	1	576Ω ±1% resistor (0402)			
R37	1	332Ω ±1% resistor (0402)			
RXRF, TXRF, CLKOUT, RXBBI, RXBBQ, TXBBI, TXBBQ, FREF	8	SMA edge-mount connectors, round Johnson 142-0701-801			
T1, T2	2	2.4GHz RF baluns Murata LDB182G5010G-120			
U1, U3	2	Low-noise differential ADC drivers ADI AD8139			
U2, U6	2	MAX4444ESE+ (16-pin narrow SO)			
U4	1	MAX2837ETM+ (48-pin thin QFN-EP, 6mm x 6mm x 0.8mm)			
U7	1	Low-dropout linear regulator MAX8887EZK29+ (5-pin SOT23)			
U8, U9	2	SN74LVTH244ADB Texas Instruments SN74LVTH244ADBR			
U10	1	Low-dropout voltage reference MAX6062AEUR+ (3-pin SOT23)			
U11	1	40MHz TCXO Kyocera KT3225N40000ECV28ZAA			
U12–U14	3	Ultra-low-noise LDOs MAX8510EXK29+ (5-pin SC70)			
_	16	Shunts (JPB1–JPB7, JPSHDNB, RXBBBUF, RXEN, TXEN, VCCVCO, VCCVCO1, VCCVCO2) Sullins SSC02SYAN			
_	1	PCB: MAX9835/7 EVALUATION KIT+			

### Evaluates: MAX2837

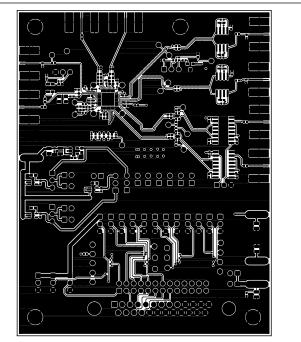


#### MAX2837 EV Kit PCB Layout Diagrams (continued)

MAX2837 EV Kit PCB Layout—Top Silkscreen



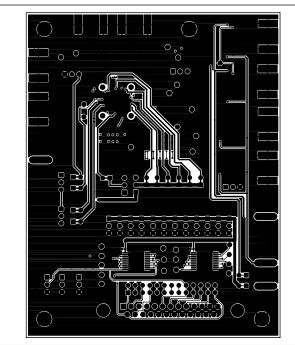
MAX2837 EV Kit PCB Layout—Inner Layer 2 (Ground Layer)



MAX2837 EV Kit PCB Layout—Component Side

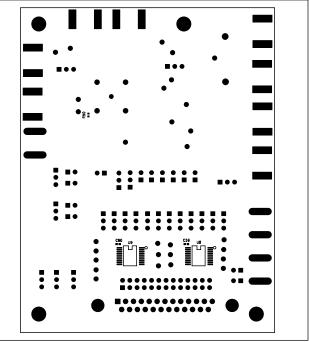


MAX2837 EV Kit PCB Layout—Inner Layer 3 (Routes)



# MAX2837 EV Kit PCB Layout Diagrams (continued)

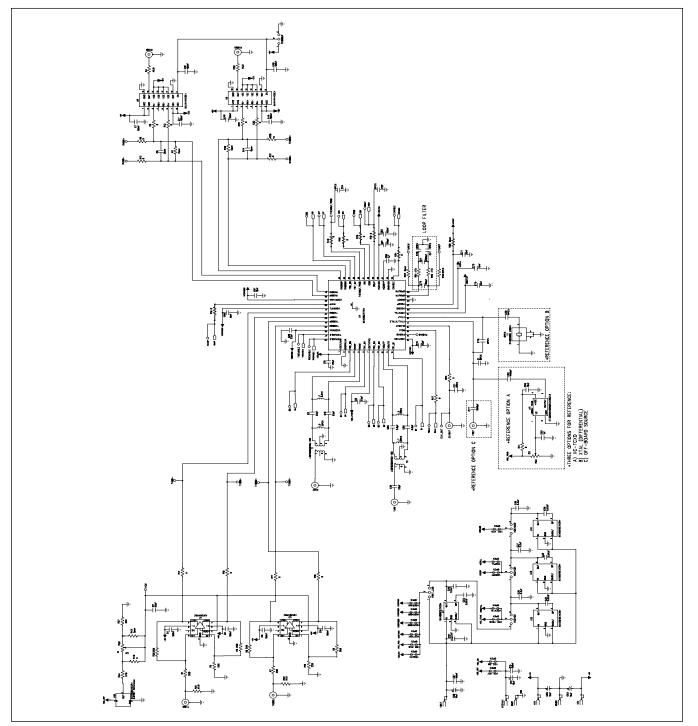
MAX2837 EV Kit PCB Layout—Inner Layer 2 (Ground Layer)



MAX2837 EV Kit PCB Layout—Bottom Silkscreen

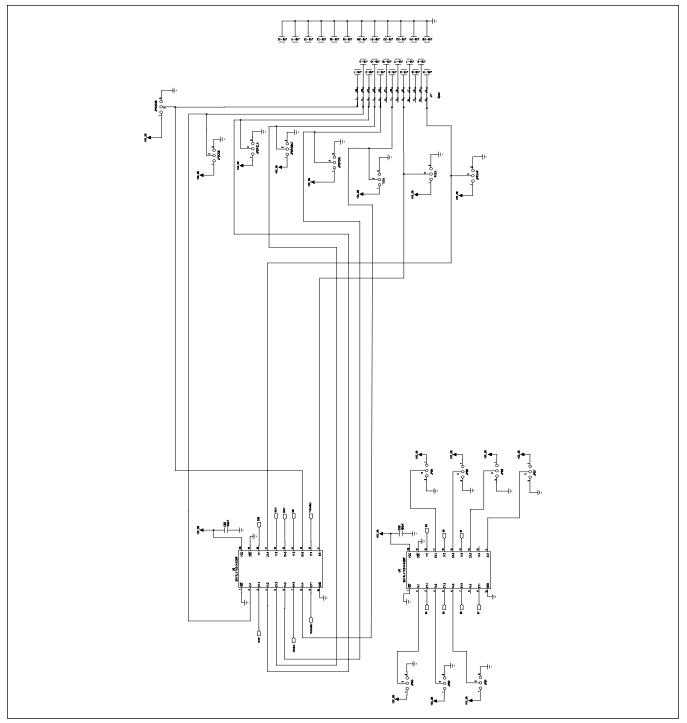
## Evaluates: MAX2837

## MAX2837 EV Kit Schematic



MAX2837 EV Kit Schematic (Sheet 1 of 2)

Evaluates: MAX2837



## MAX2837 EV Kit Schematic (continued)

MAX2837 EV Kit Schematic (Sheet 2 of 2)

# Evaluates: MAX2837

# **Ordering Information**

PART	TYPE
MAX2837EVKIT+	EV Kit

+Denotes a lead-free and RoHS-compliant EV kit.

### Evaluates: MAX2837

#### **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	8/07	Initial release	—
1	11/14	Updated Quick Start section	3
2	1/16	General improvements to EV kit data sheet	1–4

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

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